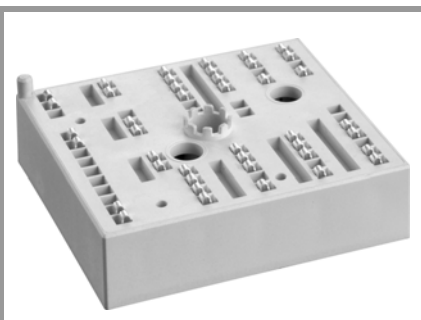


# SKiiP 24NAB176V1



MiniSKiiP® 2

3-phase bridge rectifier +  
brake chopper + 3-phase  
bridge inverter

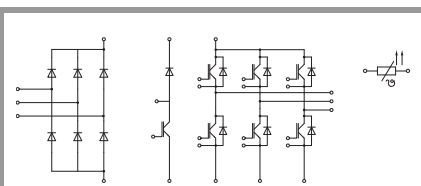
## SKiiP 24NAB176V1

### Features

- Trench IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised: File no. E63532

### Remarks

- Max. case temperature limited to  $T_C=125^{\circ}\text{C}$
- Product reliability results valid for  $T_j \leq 125^{\circ}\text{C}$  (recommended  $T_{j,op} = -40 \dots +125^{\circ}\text{C}$ )
- $I_{t(RMS)}$  limited to 20A for +B, B, -B, -DC/ U, -DC/V, -DC/W power connectors
- The distance between terminals of temperature sensor and -DC/W is not sufficient for basic insulation
- The distance between terminals of +rect, +B and +DC not sufficient for basic insulation
- The distance between terminals of -B, -DC/U, DC/V and -DC/W not sufficient for basic insulation

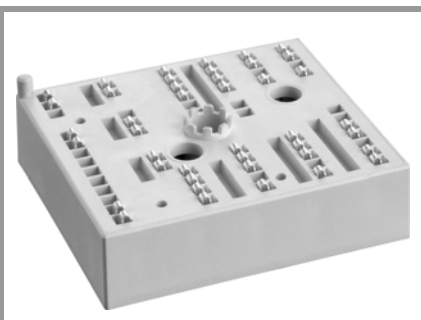


NAB

### Absolute Maximum Ratings

Symbol	Conditions	Values	Unit	
<b>Inverter - IGBT</b>				
$V_{CES}$	$T_j = 25^{\circ}\text{C}$	1700	V	
$I_C$	$T_j = 125^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	33	A
		$T_s = 70^{\circ}\text{C}$	23	A
$I_C$	$T_j = 150^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	38	A
		$T_s = 70^{\circ}\text{C}$	29	A
$I_{Cnom}$		29	A	
$I_{CRM}$	$I_{CRM} = 2 \times I_{Cnom}$	58	A	
$V_{GES}$		-20 ... 20	V	
$t_{psc}$	$V_{CC} = 1200\text{ V}$ $V_{GE} \leq 20\text{ V}$ $V_{CES} \leq 1700\text{ V}$ $T_j = 125^{\circ}\text{C}$	10	$\mu\text{s}$	
$T_j$		-55 ... 150	$^{\circ}\text{C}$	
<b>Chopper - IGBT</b>				
$V_{CES}$	$T_j = 25^{\circ}\text{C}$	1700	V	
$I_C$	$T_j = 125^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	33	A
		$T_s = 70^{\circ}\text{C}$	23	A
$I_C$	$T_j = 150^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	38	A
		$T_s = 70^{\circ}\text{C}$	29	A
$I_{Cnom}$		29	A	
$I_{CRM}$	$I_{CRM} = 2 \times I_{Cnom}$	58	A	
$V_{GES}$		-20 ... 20	V	
$t_{psc}$	$V_{CC} = 1200\text{ V}$ $V_{GE} \leq 20\text{ V}$ $V_{CES} \leq 1700\text{ V}$ $T_j = 125^{\circ}\text{C}$	10	$\mu\text{s}$	
$T_j$		-55 ... 150	$^{\circ}\text{C}$	
<b>Inverse - Diode</b>				
$V_{RRM}$	$T_j = 25^{\circ}\text{C}$	1700	V	
$I_F$	$T_j = 125^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	37	A
		$T_s = 70^{\circ}\text{C}$	24	A
$I_F$	$T_j = 175^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	48	A
		$T_s = 70^{\circ}\text{C}$	38	A
$I_{Fnom}$		40	A	
$I_{FRM}$	$I_{FRM} = 2 \times I_{Fnom}$	80	A	
$I_{FSM}$	$t_p = 10\text{ ms, sin } 180^{\circ}, T_j = 150^{\circ}\text{C}$	280	A	
$T_j$		-40 ... 175	$^{\circ}\text{C}$	
<b>Freewheeling - Diode</b>				
$V_{RRM}$	$T_j = 25^{\circ}\text{C}$	1700	V	
$I_F$	$T_j = 125^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	37	A
		$T_s = 70^{\circ}\text{C}$	24	A
$I_F$	$T_j = 175^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	48	A
		$T_s = 70^{\circ}\text{C}$	38	A
$I_{Fnom}$		40	A	
$I_{FRM}$	$I_{FRM} = 2 \times I_{Fnom}$	80	A	
$I_{FSM}$	$t_p = 10\text{ ms, sin } 180^{\circ}, T_j = 150^{\circ}\text{C}$	280	A	
$T_j$		-40 ... 175	$^{\circ}\text{C}$	

# SKiiP 24NAB176V1



MiniSKiiP® 2

3-phase bridge rectifier +  
brake chopper + 3-phase  
bridge inverter

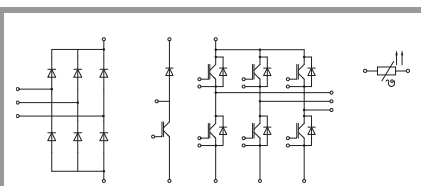
## SKiiP 24NAB176V1

### Features

- Trench IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised: File no. E63532

### Remarks

- Max. case temperature limited to  $T_C=125^\circ\text{C}$
- Product reliability results valid for  $T_j \leq 125^\circ\text{C}$  (recommended  $T_{j,op} = -40 \dots +125^\circ\text{C}$ )
- $I_{t(RMS)}$  limited to 20A for +B, B, -B, -DC/U, -DC/V, -DC/W power connectors
- The distance between terminals of temperature sensor and -DC/W is not sufficient for basic insulation
- The distance between terminals of +rect, +B and +DC not sufficient for basic insulation
- The distance between terminals of -B, -DC/U, DC/V and -DC/W not sufficient for basic insulation

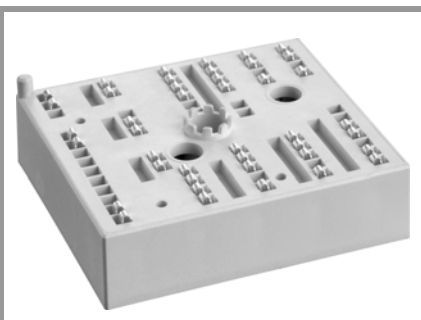


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Absolute Maximum Ratings			
Symbol	Conditions	Values	Unit
<b>Rectifier - Diode</b>			
$V_{RRM}$	$T_j = 25^\circ\text{C}$	1800	V
$I_F$	$T_s = 25^\circ\text{C}, T_j = 150^\circ\text{C}$	59	A
$I_{Fnom}$	DC current	41	A
$I_{FSM}$	10 ms	$T_j = 25^\circ\text{C}$	A
	sin 180°	$T_j = 150^\circ\text{C}$	A
$I^2t$	10 ms	$T_j = 25^\circ\text{C}$	A <sup>2</sup> s
	sin 180°	$T_j = 150^\circ\text{C}$	A <sup>2</sup> s
$T_j$		-40 ... 150	°C
<b>Module</b>			
$I_{t(RMS)}$	$T_{terminal} = 80^\circ\text{C}, 20\text{ A per spring}$	40	A
$T_{stg}$		-40 ... 125	°C
$V_{isol}$	AC sinus 50 Hz, 1 min	2500	V

Characteristics					
Symbol	Conditions	min.	typ.	max.	Unit
<b>Inverter - IGBT</b>					
$V_{CE(sat)}$	$I_C = 29\text{ A}$ $V_{GE} = 15\text{ V}$ chipllevel	$T_j = 25^\circ\text{C}$	2.00	2.45	V
		$T_j = 125^\circ\text{C}$	2.45	2.90	V
$V_{CE0}$	chipllevel	$T_j = 25^\circ\text{C}$	1	1.2	V
		$T_j = 125^\circ\text{C}$	0.9	1.1	V
$r_{CE}$	$V_{GE} = 15\text{ V}$ chipllevel	$T_j = 25^\circ\text{C}$	34	43	mΩ
		$T_j = 125^\circ\text{C}$	53	62	mΩ
$V_{GE(th)}$	$V_{GE} = V_{CE}\text{ V}, I_C = 1.2\text{ mA}$	5.2	5.8	6.4	V
$I_{CES}$	$V_{GE} = 0\text{ V}$ $V_{CE} = 1700\text{ V}$	$T_j = 25^\circ\text{C}$	0.1	0.3	mA
					mA
$C_{ies}$	$V_{CE} = 25\text{ V}$ $V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$	2.50		nF
$C_{oes}$		$f = 1\text{ MHz}$	0.11		nF
$C_{res}$		$f = 1\text{ MHz}$	0.08		nF
$Q_G$	- 8 V...+ 15 V		240		nC
$R_{Gint}$	$T_j = 25^\circ\text{C}$		32		Ω
$t_{d(on)}$	$V_{CC} = 900\text{ V}$ $I_C = 20\text{ A}$	$T_j = 125^\circ\text{C}$	290		ns
$t_r$	$R_{G\ on} = 1\ \Omega$ $R_{G\ off} = 1\ \Omega$	$T_j = 125^\circ\text{C}$	40		ns
$E_{on}$		$T_j = 125^\circ\text{C}$	5.1		mJ
$t_{d(off)}$	$di/dt_{on} = 580\text{ A}/\mu\text{s}$	$T_j = 125^\circ\text{C}$	690		ns
$t_f$	$di/dt_{off} = 120\text{ A}/\mu\text{s}$ $du/dt = 4000\text{ V}/\mu\text{s}$	$T_j = 125^\circ\text{C}$	120		ns
$E_{off}$	$V_{GE} = +15/-15\text{ V}$ $L_s = 47\text{ nH}$	$T_j = 125^\circ\text{C}$	6.3		mJ
$R_{th(j-s)}$	per IGBT, $\lambda_{paste}=0.8\text{ W/K}^2\text{m}$		0.91		K/W
<b>Chopper - IGBT</b>					
$V_{CE(sat)}$	$I_C = 29\text{ A}$ $V_{GE} = 15\text{ V}$ chipllevel	$T_j = 25^\circ\text{C}$	2.00	2.45	V
		$T_j = 125^\circ\text{C}$	2.45	2.90	V
$V_{CE0}$	chipllevel	$T_j = 25^\circ\text{C}$	1	1.2	V
		$T_j = 125^\circ\text{C}$	0.9	1.1	V
$r_{CE}$	$V_{GE} = 15\text{ V}$ chipllevel	$T_j = 25^\circ\text{C}$	34	43	mΩ
		$T_j = 125^\circ\text{C}$	53	62	mΩ
$V_{GE(th)}$	$V_{GE} = V_{CE}\text{ V}, I_C = 1.2\text{ mA}$	5.2	5.8	6.4	V
$I_{CES}$	$V_{GE} = 0\text{ V}$ $V_{CE} = 1700\text{ V}$	$T_j = 25^\circ\text{C}$	0.1	0.3	mA
		$T_j = 125^\circ\text{C}$			mA
$Q_G$	- 8 V...+ 15 V		240		nC
$R_{Gint}$	$T_j = 25^\circ\text{C}$		32		Ω

# SKiiP 24NAB176V1



MiniSKiiP® 2

3-phase bridge rectifier +  
brake chopper + 3-phase  
bridge inverter

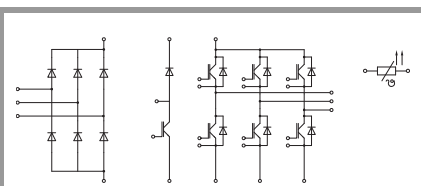
## SKiiP 24NAB176V1

### Features

- Trench IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised: File no. E63532

### Remarks

- Max. case temperature limited to  $T_C=125^\circ\text{C}$
- Product reliability results valid for  $T_j \leq 125^\circ\text{C}$  (recommended  $T_{j,op} = -40 \dots +125^\circ\text{C}$ )
- $I_{t(RMS)}$  limited to 20A for +B, B, -B, -DC/U, -DC/V, -DC/W power connectors
- The distance between terminals of temperature sensor and -DC/W is not sufficient for basic insulation
- The distance between terminals of +rect, +B and +DC not sufficient for basic insulation
- The distance between terminals of -B, -DC/U, DC/V and -DC/W not sufficient for basic insulation



NAB

Characteristics						
Symbol	Conditions	min.	typ.	max.	Unit	
<b>Chopper - IGBT</b>						
$t_{d(on)}$	$V_{CC} = 900\text{ V}$	$T_j = 125^\circ\text{C}$	290		ns	
$t_r$	$I_C = 20\text{ A}$	$T_j = 125^\circ\text{C}$	40		ns	
$E_{on}$	$R_{G\ on} = 1\ \Omega$	$T_j = 125^\circ\text{C}$	5.1		mJ	
$t_{d(off)}$	$R_{G\ off} = 1\ \Omega$	$T_j = 125^\circ\text{C}$	690		ns	
$t_f$	$di/dt_{on} = 580\text{ A}/\mu\text{s}$	$T_j = 125^\circ\text{C}$	120		ns	
$E_{off}$	$du/dt = 4000\text{ V}/\mu\text{s}$	$T_j = 125^\circ\text{C}$	6.3		mJ	
$R_{th(j-s)}$	per Diode, $\lambda_{paste}=0.8\text{ W}/\text{K}^*\text{m}$		0.91		K/W	
<b>Inverse - Diode</b>						
$V_F = V_{EC}$	$I_F = 40\text{ A}$	$T_j = 25^\circ\text{C}$	2	2.4	V	
	$V_{GE} = 0\text{ V}$	$T_j = 150^\circ\text{C}$	2.1	2.6	V	
	chiplevel					
$V_{F0}$		$T_j = 25^\circ\text{C}$	1.3	1.6	V	
	chiplevel	$T_j = 150^\circ\text{C}$	1.1	1.2	V	
$r_F$		$T_j = 25^\circ\text{C}$	17	20	m $\Omega$	
	chiplevel	$T_j = 150^\circ\text{C}$	27	33	m $\Omega$	
$I_{RRM}$	$I_F = 20\text{ A}$	$T_j = 125^\circ\text{C}$	32.7		A	
$Q_{rr}$	$di/dt_{off} = 620\text{ A}/\mu\text{s}$	$T_j = 125^\circ\text{C}$	8.7		$\mu\text{C}$	
$E_{rr}$	$V_{GE} = -15\text{ V}$	$T_j = 125^\circ\text{C}$	4.9		mJ	
	$V_{CC} = 900\text{ V}$	$T_j = 125^\circ\text{C}$				
$R_{th(j-s)}$	per Diode, $\lambda_{paste}=0.8\text{ W}/\text{K}^*\text{m}$		1.14		K/W	
<b>Freewheeling - Diode</b>						
$V_F = V_{EC}$	$I_F = 40\text{ A}$	$T_j = 25^\circ\text{C}$	2	2.4	V	
	$V_{GE} = 0\text{ V}$	$T_j = 150^\circ\text{C}$	2.1	2.6	V	
	chiplevel					
$V_{F0}$		$T_j = 25^\circ\text{C}$	1.3	1.6	V	
	chiplevel	$T_j = 150^\circ\text{C}$	1.1	1.2	V	
$r_F$		$T_j = 25^\circ\text{C}$	17	20	m $\Omega$	
	chiplevel	$T_j = 150^\circ\text{C}$	27	33	m $\Omega$	
$I_{RRM}$	$I_F = 20\text{ A}$	$T_j = 125^\circ\text{C}$	32.7		A	
$Q_{rr}$	$di/dt_{off} = 620\text{ A}/\mu\text{s}$	$T_j = 125^\circ\text{C}$	8.7		$\mu\text{C}$	
$E_{rr}$	$V_{GE} = -15\text{ V}$	$T_j = 125^\circ\text{C}$	4.9		mJ	
	$V_{CC} = 900\text{ V}$	$T_j = 125^\circ\text{C}$				
$R_{th(j-s)}$	per Diode, $\lambda_{paste}=0.8\text{ W}/\text{K}^*\text{m}$		1.14		K/W	
<b>Rectifier - Diode</b>						
$V_F = V_{EC}$	$I_F = 41\text{ A}$	$T_j = 25^\circ\text{C}$	1.2	1.5	V	
	$V_{GE} = 0\text{ V}$	$T_j = 125^\circ\text{C}$	1.2	1.4	V	
	chiplevel					
$V_{F0}$		$T_j = 25^\circ\text{C}$	0.6	0.9	1.1	V
	chiplevel	$T_j = 125^\circ\text{C}$	0.7	1	V	
$r_F$		$T_j = 25^\circ\text{C}$	7.9	8.7	m $\Omega$	
	chiplevel	$T_j = 125^\circ\text{C}$	10	11	m $\Omega$	
$R_{th(j-s)}$	per Diode, $\lambda_{paste}=0.8\text{ W}/\text{K}^*\text{m}$		1.32		K/W	
<b>Module</b>						
$M_s$	to heat sink	2		2.5	Nm	
w			55		g	
$L_{CE}$			31		nH	
<b>Temperature Sensor</b>						
$R_{100}$	$T_r = 100^\circ\text{C}$ , tolerance = 3 %		1670 $\pm$ 3%		$\Omega$	
$R(T)$	$R(T) = 1000\Omega [1 + A(T - 25^\circ\text{C}) + B(T - 25^\circ\text{C})^2]$ A = $7.635 \cdot 10^{-3}\text{ }^\circ\text{C}^{-1}$ , B = $1.731 \cdot 10^{-5}\text{ }^\circ\text{C}^{-2}$					

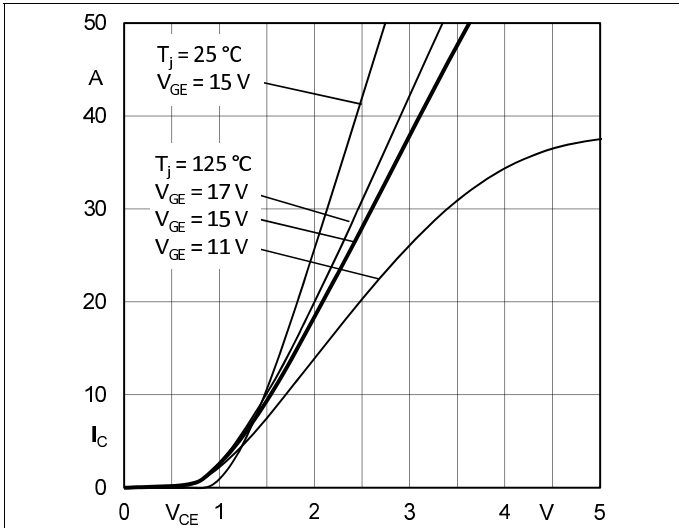


Fig. 1: Typ. output characteristic, inclusive R<sub>CC'+EE'</sub>

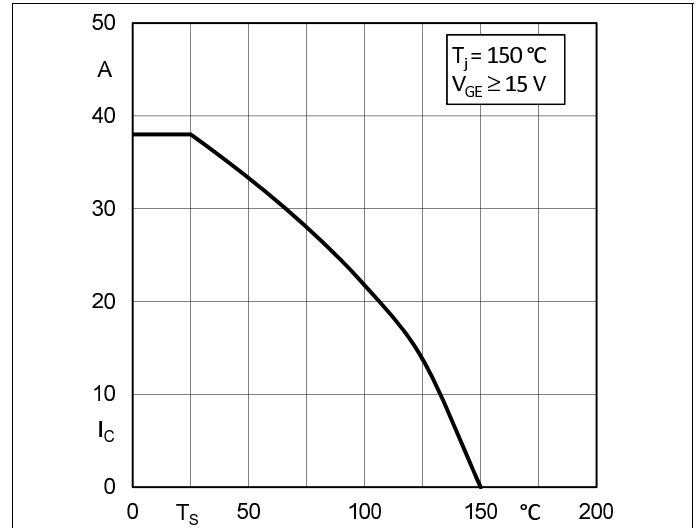


Fig. 2: Typ. rated current vs. temperature I<sub>C</sub> = f(T<sub>S</sub>)

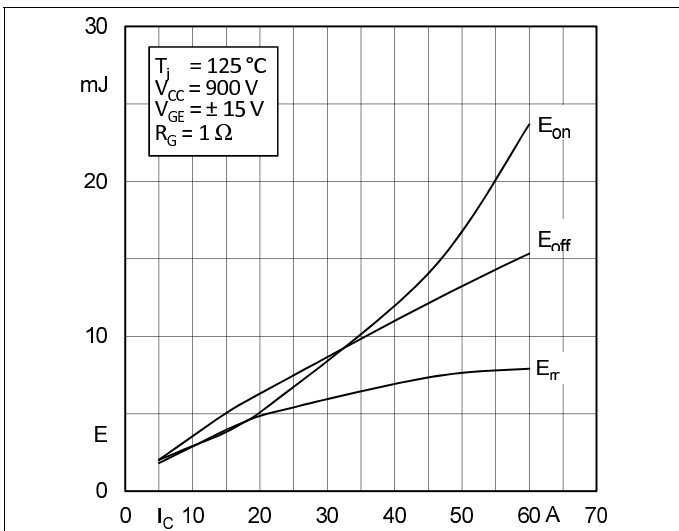


Fig. 3: Typ. turn-on /-off energy = f(I<sub>C</sub>)

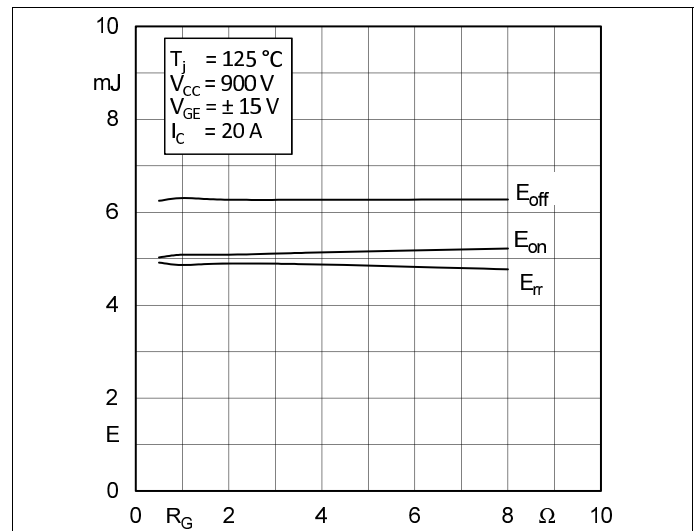


Fig. 4: Typ. turn-on /-off energy = f(R<sub>G</sub>)

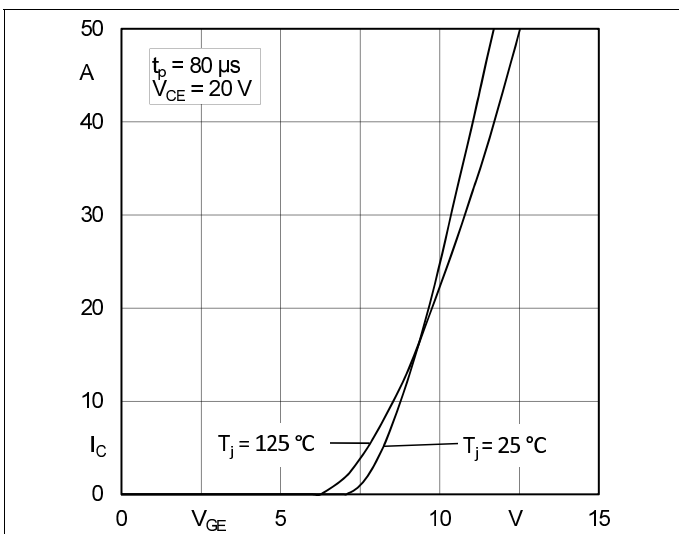


Fig. 5: Typ. transfer characteristic

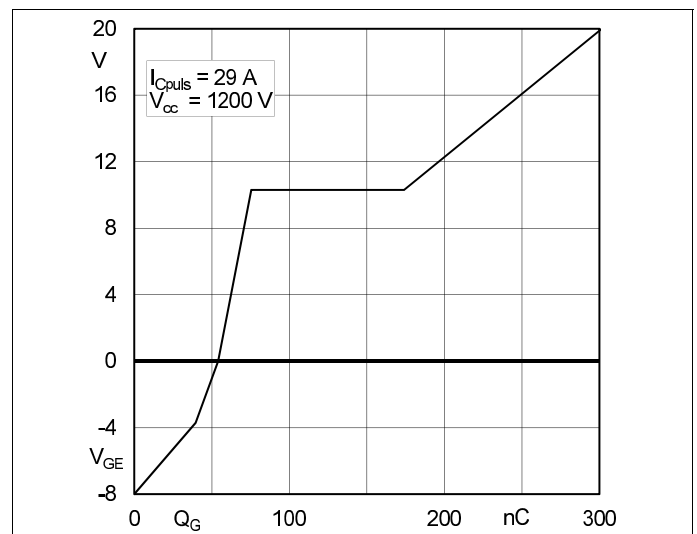


Fig. 6: Typ. gate charge characteristic

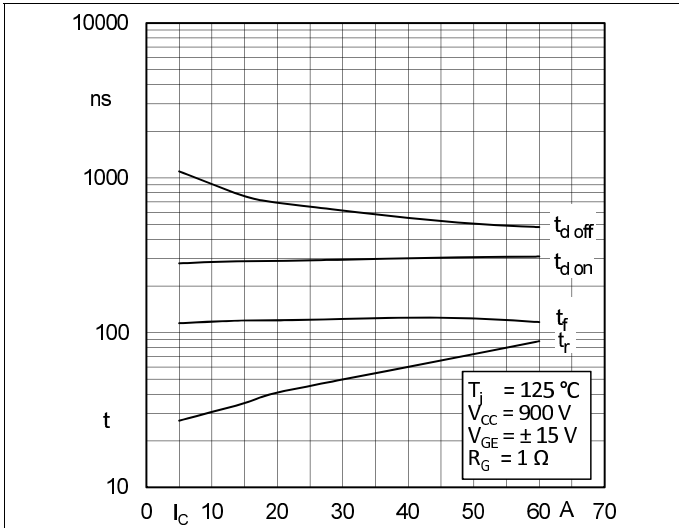


Fig. 7: Typ. switching times vs.  $I_c$

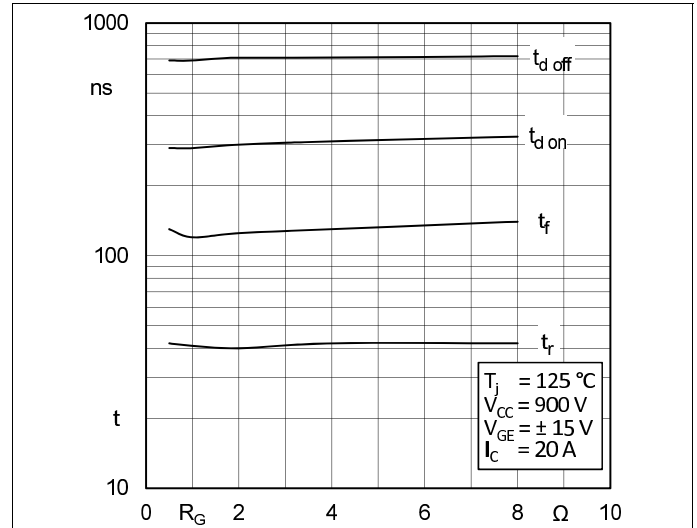


Fig. 8: Typ. switching times vs. gate resistor  $R_G$

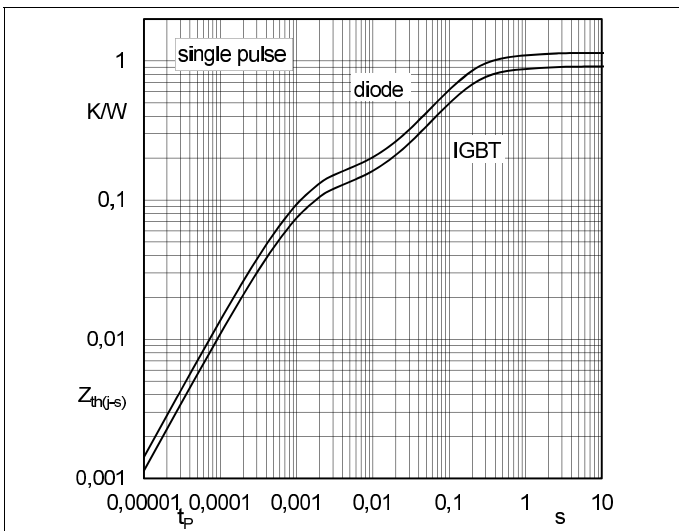


Fig. 9: Transient thermal impedance of IGBT and Diode

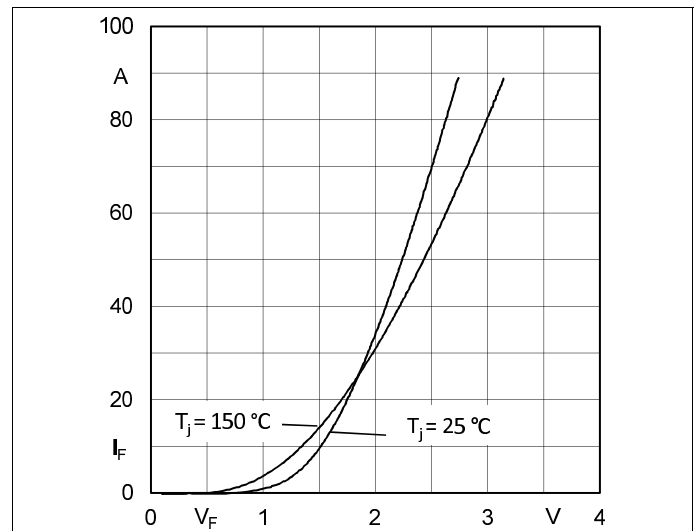


Fig. 10: CAL diode forward characteristic

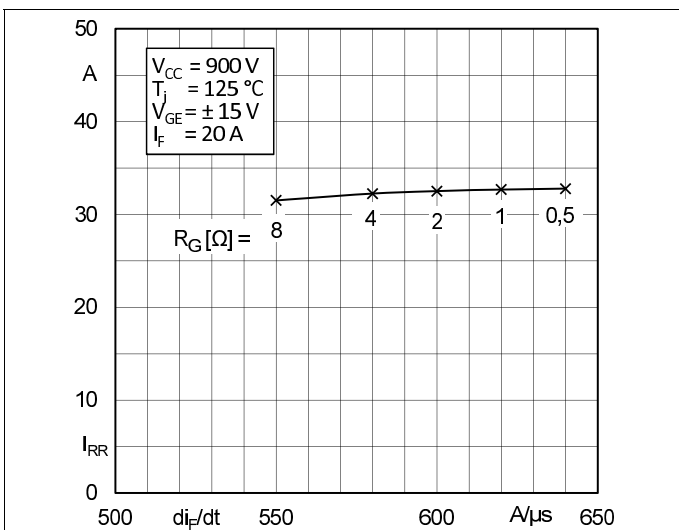


Fig. 11: Typ. CAL diode peak reverse recovery current

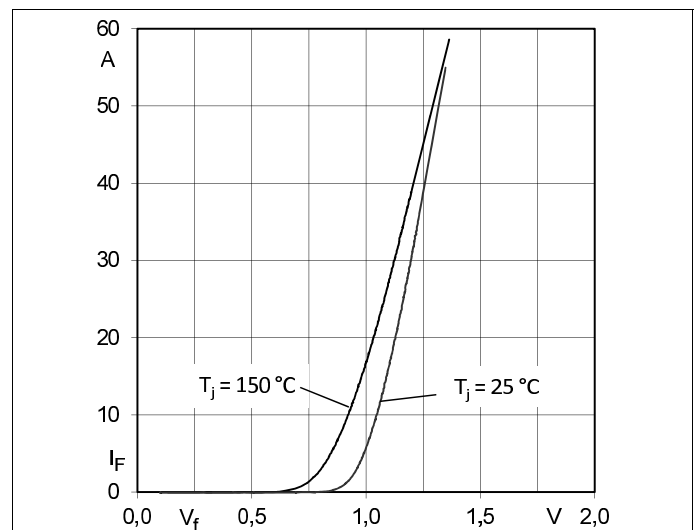
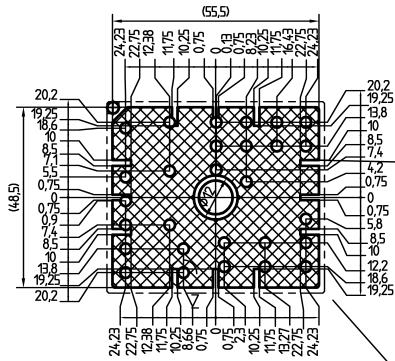


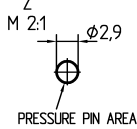
Fig. 12: Typ. input bridge forward characteristic

## PCB PCB TOP-VIEW

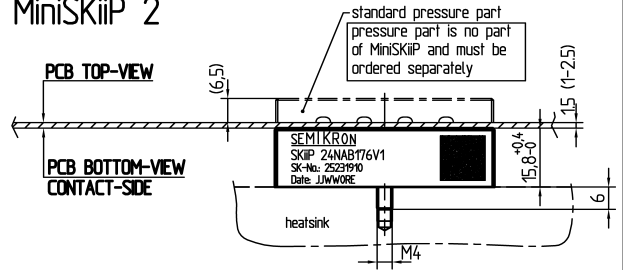


Only for the standard pressure part:  
Accessible for mounting of SMD (max height 3.5) on PCB by customer

mounting area

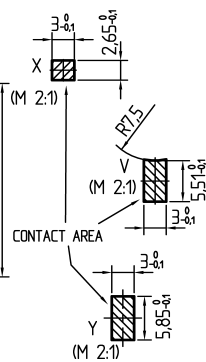
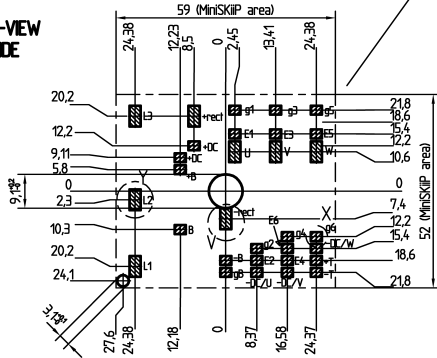


## MiniSKiiP 2

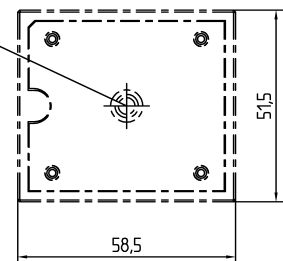


## PCB TOP-VIEW PCB BOTTOM-VIEW CONTACT-SIDE

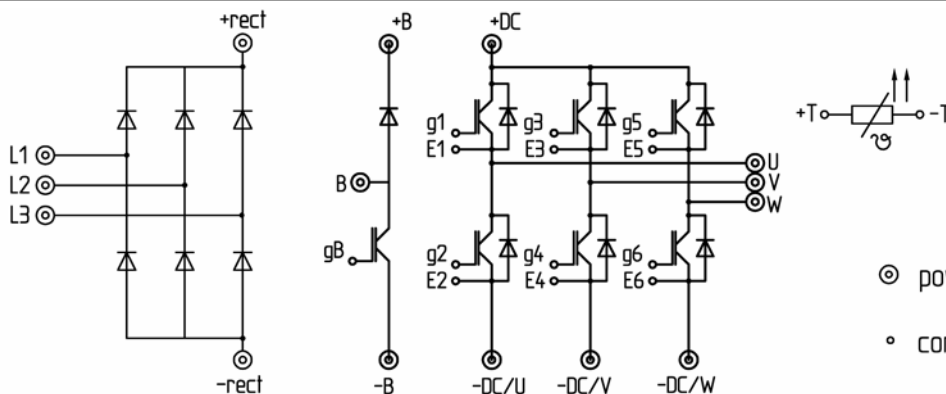
## PCB BOTTOM-VIEW CONTACT-SIDE



For mounting please follow the assembly instruction



## pinout, dimensions



## pinout

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.